

**PATENT** 

### IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

IN RE APPLICATION OF: ERIC J. BERGMAN

APPLICATION No.:

10/681,553

FILED:

OCTOBER 7, 2003

FOR: METHODS FOR CLEANING SEMICONDUCTOR

**SURFACES** 

**EXAMINER:** 

ART UNIT:

1746

CONF. NO:

7774

## SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

## 1. <u>Timing of Submission</u>

This supplemental IDS is believed to be timely in that it is being submitted under 37 CFR § 1.97(b), that is (1) within three months of the filing date of the application, which is not a continued prosecution application filed under § 1.53(d); or (2) within three months of entry of the national stage as set forth in 37 CFR § 1.491; or (3) before the mailing of a first Office action on the merits; or (4) before the mailing of a first Office action after filing a request for continued examination under § 1.114. Thus, no fee is required. The references listed on the enclosed Form PTO-1449 (modified) may be material to the examination of this application; the Examiner is requested to make them of record in the application.

#### 2. Cited References

Copies of all cited references are enclosed.

#### **Certificate of Mailing**

I hereby certify that this paper (along with any referred to as being attached or enclosed) is being deposited with the United States Postal Service on the date shown below with sufficient postage in an envelope addressed to Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

Date of Deposit

Debbie Gilbert

# 3. Effect of Information Disclosure Statement (37 C.F.R. § 1.97(h))

This Information Disclosure Statement is not to be construed as a representation that: (i) a search has been made; (ii) additional information material to the examination of this application does not exist; (iii) the information, protocols, results and the like reported by third parties are accurate or enabling; or (iv) the cited information is, or is considered to be, material to patentability. In addition, applicant does not admit that any enclosed item of information constitutes prior art to the subject invention and specifically reserves the right to demonstrate that any such reference is not prior art.

## 4. Fee Payment

No fees are believed due because this Information Disclosure Statement is being filed before the mailing of a first Office Action.

Dated:

\_, 2004

Respectfully submitted,

Customer No. 34055

Perkins Coie LLP

Patent - LA

P.O. Box 1208

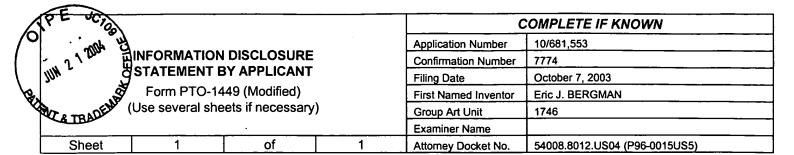
Seattle, WA 98111-1208

Phone: (310) 788-9900 Fax: (310) 788-3399 PERKINS COIE LLP

By: Kennel

Kenneth H. Ohriner

Reg. No. 31,646



					U.S. PATENT DOCUMENTS			
Examiner Initials*	Cite No.	U.S. F		ication ind Code if known)	Name of Patentee or Inventor of Cited Document	Date of Publication or Filing Date of Cited Document	Pages, Columns, Lines Where Relevant Passage Relevant Figures Appe	s or
	EZ	6,551,	409		DeGendt	04/22/03		
	FA	2002/0011257			DeGendt	01/31/02	/31/02	
				F	OREIGN PATENT DOCUMENTS			
Examiner Initials*	Cite No.	Foreig Office	gn Patent or A	Kind Co		Date of Publication or Filing Date of Cited Document	Pages, Columns, Lines, Where Relevant Passages or Relevant Figures Appear	Т
•			OTHER	PRIOR	ART-NON PATENT LITERATURE	DOCUMENTS		
•		1					a) title of the item	$\blacksquare$
Examiner Initials*	Cite No.	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume issue number(s), publisher, city and/or country where published.  Golland, D.E., et al., "The Clean Module: Advanced Technology for Processing Silicon Wafers." Semiconductor Int'l., pp. 154-157 (Sep. 1987).						Т
	FB							
			,	,				

EXAMINER	DATE CONSIDERED		
*EVANDIED.	 with MDED 600. Down tire the such citation if not in an formation and not		

\*EXAMINER: Initial if reference considered, whether or not criteria is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to application(s).